
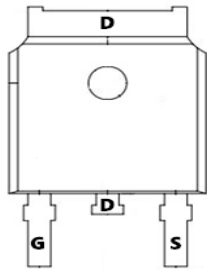


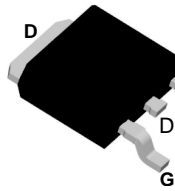
TM6N04D

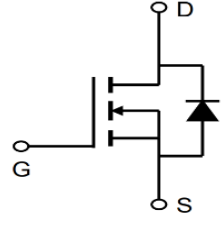
N-Channel Enhancement Mosfet

| | |
|--|--|
| <p>General Description</p> <ul style="list-style-type: none"> • Low $R_{DS(ON)}$ • RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> • Load switch • PWM | <p>General Features</p> <p>$V_{DS} = 40V$ $I_D = 60A$</p> <p>$R_{DS(ON)} = 7.7m\Omega$ (Typ.) @ $V_{GS} = 10V$</p> <p>100% UIS Tested 100% R_g Tested</p>  |
|--|--|



D:TO-252-3





Marking: 60N04

Absolute Maximum Ratings ($T_C = 25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Rating | Unit | |
|--|--|---------------------|--------------|----|
| Common Ratings ($T_A = 25^\circ C$ Unless Otherwise Noted) | | | | |
| V_{DSS} | Drain-Source Voltage | 40 | V | |
| $BV_{DS(Avalanche)}^*$ | Drain-Source Avalanche Voltage (Maximum) | 45 | | |
| V_{GSS} | Gate-Source Voltage | ± 20 | | |
| T_J | Maximum Junction Temperature | 175 | $^\circ C$ | |
| T_{STG} | Storage Temperature Range | -55 to 175 | $^\circ C$ | |
| I_S | Diode Continuous Forward Current | 60 | A | |
| I_{DP} | 300 μs Pulse Drain Current Tested | $T_C = 25^\circ C$ | 160 | A |
| | | $T_C = 100^\circ C$ | 90 | |
| I_D | Continuous Drain Current | $T_C = 25^\circ C$ | 60 | A |
| | | $T_C = 100^\circ C$ | 48 | |
| P_D | Maximum Power Dissipation | $T_C = 25^\circ C$ | 60 | W |
| | | $T_C = 100^\circ C$ | 30 | |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | 2.5 | $^\circ C/W$ | |
| $R_{\theta JA}$ | Thermal Resistance-Junction to Ambient | 50 | $^\circ C/W$ | |
| E_{AS}^{**} | Drain-Source Avalanche Energy | L=0.5mH | 100 | mJ |

Notes : * Avalanche single pulse test and avalanche period time $t_{av} \leq 100 \mu s$, duty < 1% .
 ** Avalanche test condition: $T_J = 25^\circ C$, L=0.5mH, $I_{AS} = 20A$, $V_{DD} = 30V$, and $V_{GS} = 10V$.
 *** Current limited by bond wire.

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise specified)

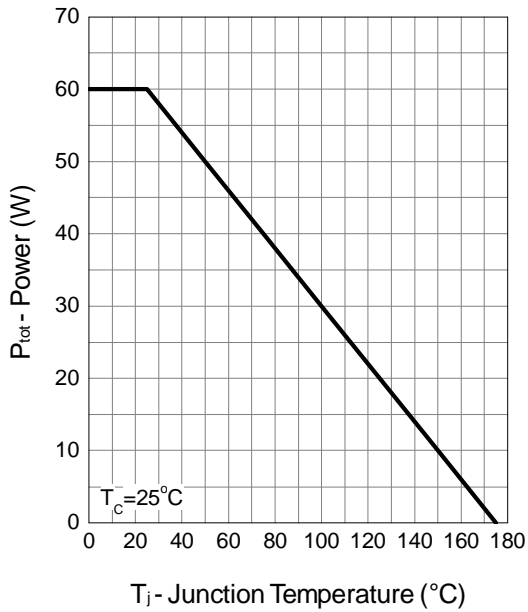
| Symbol | Parameter | Test Conditions | XP4184 | | | Unit |
|---|----------------------------------|---|--------|------|-----------|------------|
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_{DS}=250\mu A$ | 40 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=32V, V_{GS}=0V$ | - | - | 1 | μA |
| | | $T_J=85^{\circ}\text{C}$ | - | - | 30 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_{DS}=250\mu A$ | 1.0 | 1.5 | 2 | V |
| I_{GSS} | Gate Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| $R_{DS(ON)}^a$ | Drain-Source On-state Resistance | $V_{GS}=10V, I_{DS}=20A$ | - | 7.8 | 11 | m Ω |
| | | $V_{GS}=4.5V, I_{DS}=10A$ | - | 10 | 18 | |
| Diode Characteristics | | | | | | |
| V_{SD}^a | Diode Forward Voltage | $I_{SD}=20A, V_{GS}=0V$ | - | 0.8 | 1.1 | V |
| t_{rr} | Reverse Recovery Time | $I_{DS}=40A,$ $di_{SD}/dt=100A/\mu s$ | - | 28 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 24 | - | nC |
| Dynamic Characteristics ^b | | | | | | |
| R_G | Gate Resistance | $V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$ | - | 1.4 | - | Ω |
| C_{iss} | Input Capacitance | $V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz | - | 1460 | - | pF |
| C_{oss} | Output Capacitance | | - | 180 | - | |
| C_{riss} | Reverse Transfer Capacitance | | - | 146 | - | |
| $t_{d(ON)}$ | Turn-on Delay Time | $V_{DD}=20V, R_L=20\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$ | - | 11 | 21 | ns |
| t_r | Turn-on Rise Time | | - | 13 | 24 | |
| $t_{d(OFF)}$ | Turn-off Delay Time | | - | 37 | 67 | |
| t_f | Turn-off Fall Time | | - | 11 | 21 | |
| Gate Charge Characteristics ^b | | | | | | |
| Q_g | Total Gate Charge | $V_{DS}=20V, V_{GS}=10V,$ $I_{DS}=40A$ | - | 31.2 | 44 | nC |
| Q_{gs} | Gate-Source Charge | | - | 3.8 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 9 | - | |

Note a : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

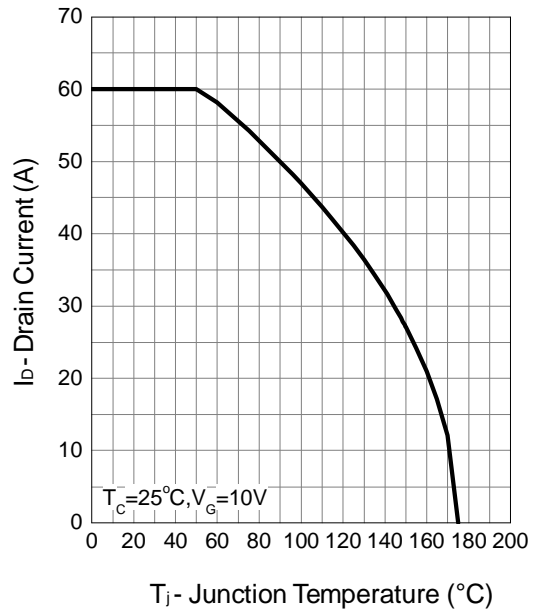
Note b : Guaranteed by design, not subject to production testing.

Typical Performance Characteristics

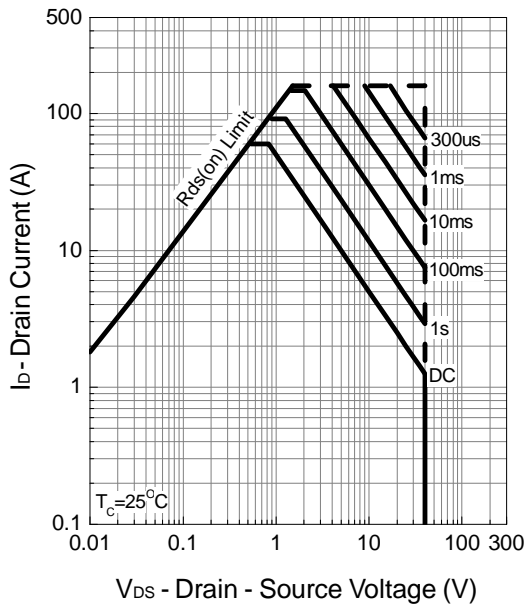
Power Dissipation



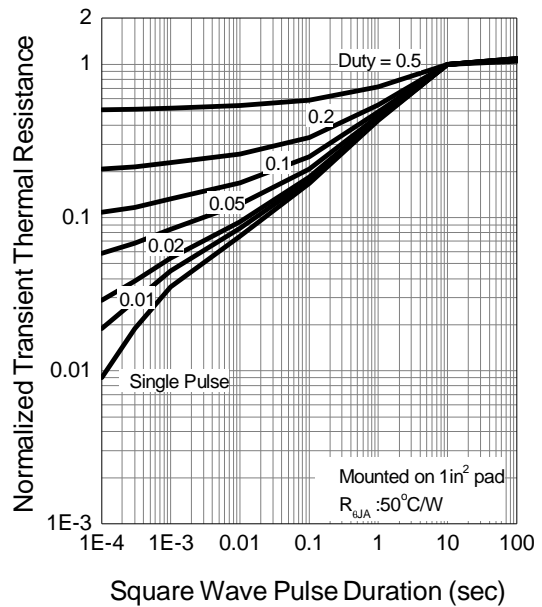
Drain Current



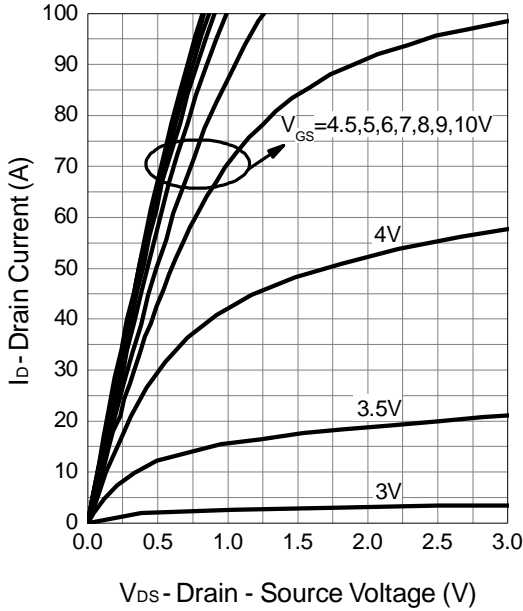
Safe Operation Area



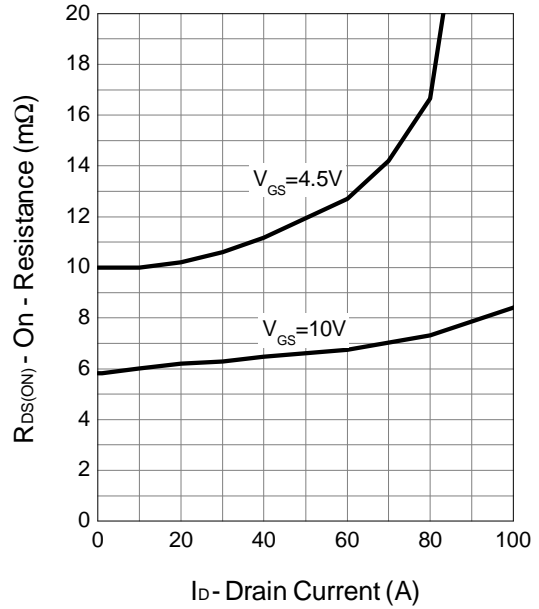
Thermal Transient Impedance



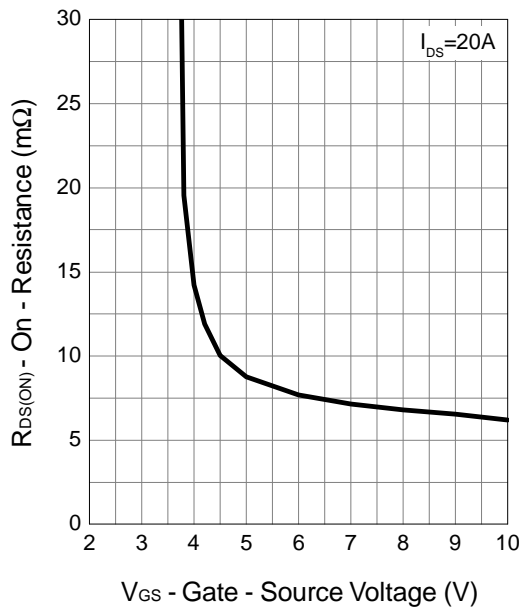
Output Characteristics



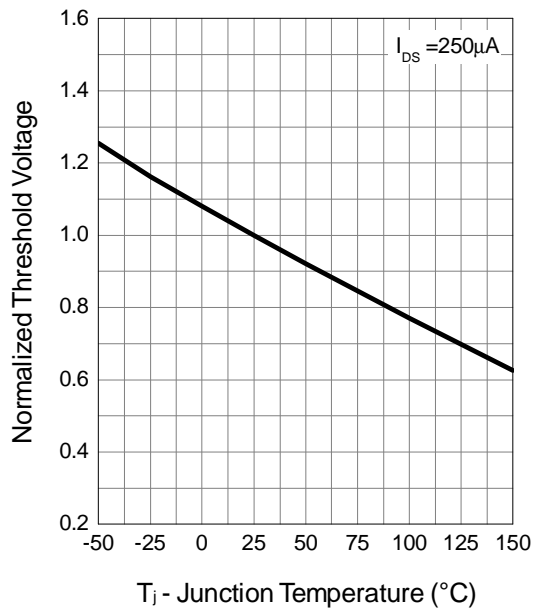
Drain-Source On Resistance



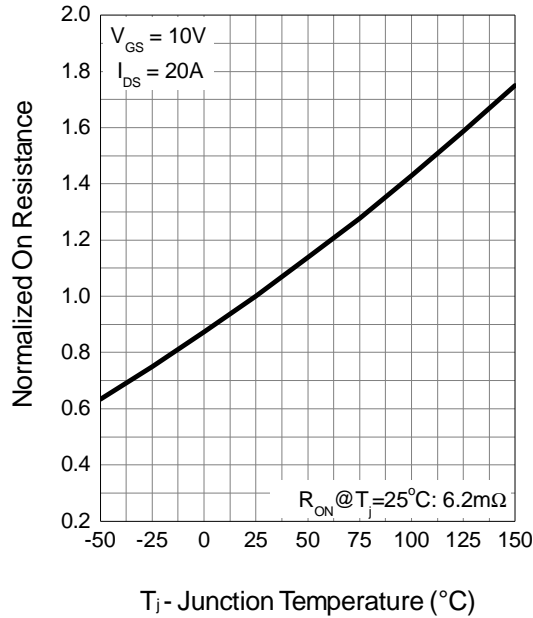
Gate-Source On Resistance



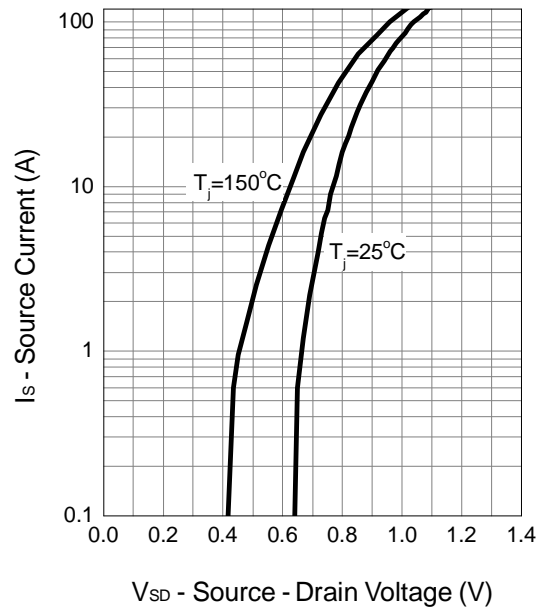
Gate Threshold Voltage



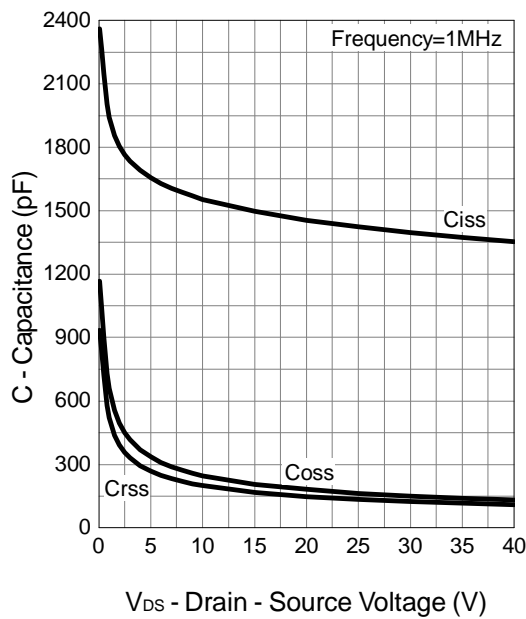
Drain-Source On Resistance



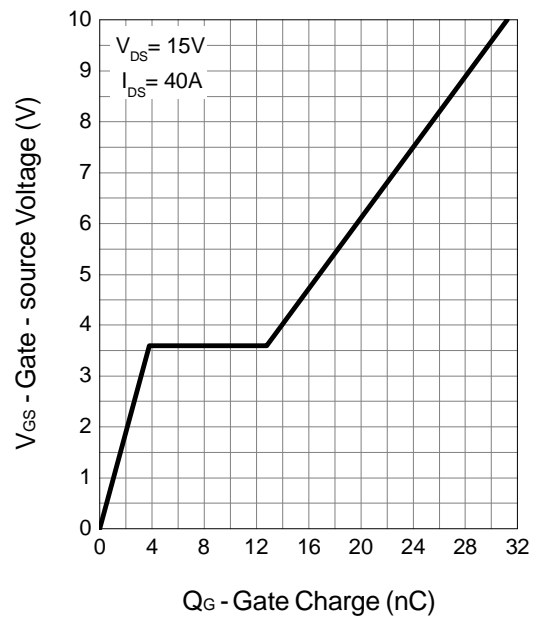
Source-Drain Diode Forward



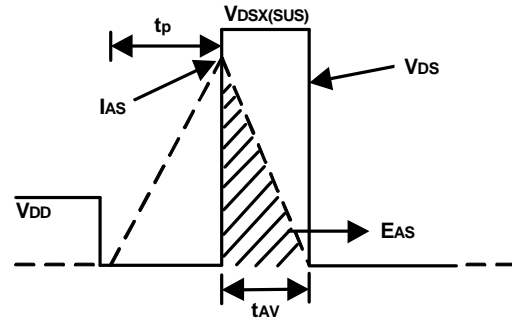
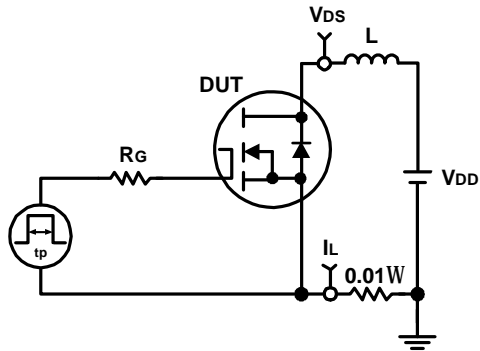
Capacitance



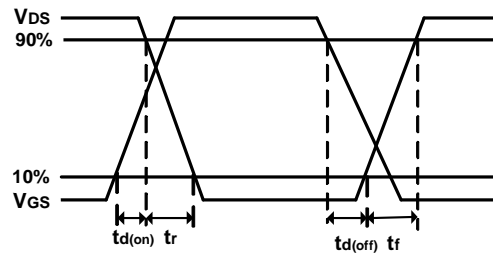
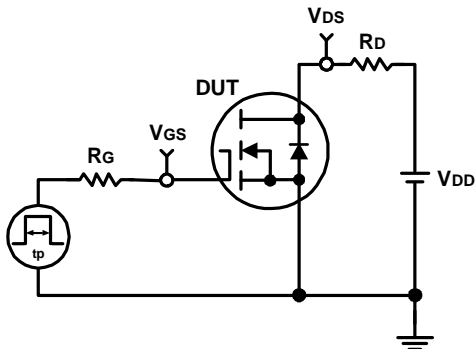
Gate Charge



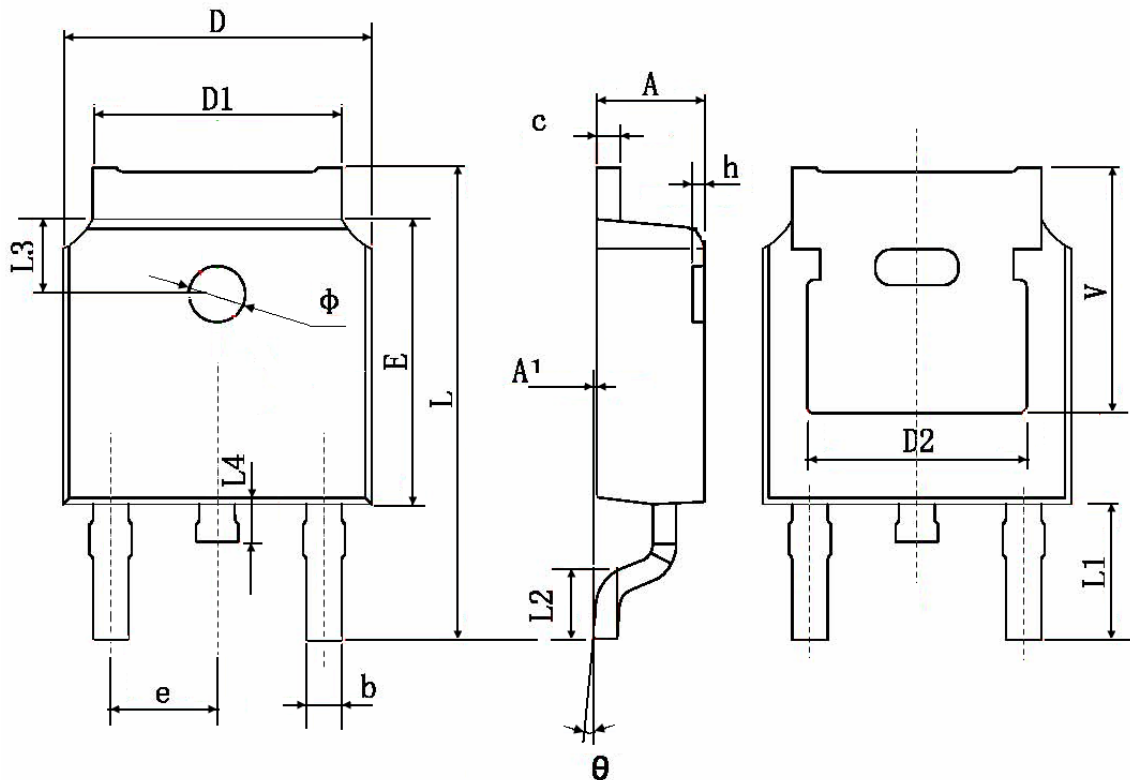
Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms



Package Information: TO-252-3L



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| b | 0.660 | 0.860 | 0.026 | 0.034 |
| c | 0.460 | 0.580 | 0.018 | 0.023 |
| D | 6.500 | 6.700 | 0.256 | 0.264 |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 |
| D2 | 4.830 TYP. | | 0.190 TYP. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.800 | 10.400 | 0.386 | 0.409 |
| L1 | 2.900 TYP. | | 0.114 TYP. | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 |
| L3 | 1.600 TYP. | | 0.063 TYP. | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 |
| φ | 1.100 | 1.300 | 0.043 | 0.051 |
| θ | 0° | 8° | 0° | 8° |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| V | 5.350 TYP. | | 0.211 TYP. | |

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